

AUTOMOTIVE N-Channel 40V 175°C MOSFET

FEATURES

- AEC-Q101 Qualified
- 100% UIS and R_g Tested
- 175°C Operating Junction Temperature
- Wettable Flank Package
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- 12V Automotive Systems
- Solenoid and Motor Control
- Automotive Transmission Control
- DC-DC Converters

PRODUCT SUMMARY		
PARAMETER	VALUE	UNIT
V_{DS}	40	V
$R_{DS(on)}$ (max)	$V_{GS} = 10V$	3.3
	$V_{GS} = 7V$	5.1
Q_g	87	nC



RoHS
COMPLIANT

**HALOGEN
FREE**



Note: MSL 1 (Moisture Sensitivity Level) per J-STD-020

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ unless otherwise noted)			
PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ^(Note 1)	I_D	121	A
$T_C = 25^\circ C$		21	
Pulsed Drain Current	I_{DM}	484	A
Single Pulse Avalanche Current ^(Note 2)	I_{AS}	36	A
Single Pulse Avalanche Energy ^(Note 2)	E_{AS}	194	mJ
Total Power Dissipation	P_D	107	W
$T_C = 125^\circ C$		36	
Total Power Dissipation	P_D	3.1	W
$T_A = 25^\circ C$		1	
Operating Junction and Storage Temperature Range	T_J, T_{STG}	- 55 to +175	°C

THERMAL RESISTANCE			
PARAMETER	SYMBOL	MAXIMUM	UNIT
Thermal Resistance – Junction to Case	R_{EJC}	1.4	°C/W
Thermal Resistance – Junction to Ambient	R_{EJA}	48	°C/W

Thermal Performance Note: R_{EJA} is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins. R_{EJC} is guaranteed by design while R_{ECA} is determined by the user's board design. The R_{EJA} limit presented here is based on mounting on a 1 in² pad of 2 oz copper.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ C$ unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	BV_{DSS}	40	--	--	V
Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250\mu A$	$V_{GS(TH)}$	1.8	2.5	3.8	V
Gate-Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$	I_{GSS}	--	--	± 100	nA
Drain-Source Leakage Current	$V_{GS} = 0V, V_{DS} = 40V$	I_{DSS}	--	--	1	μA
	$V_{GS} = 0V, V_{DS} = 40V$ $T_J = 125^\circ C$		--	--	100	
	$V_{GS} = 0V, V_{DS} = 40V$ $T_J = 175^\circ C$		--	--	500	
Drain-Source On-State Resistance <small>(Note 3)</small>	$V_{GS} = 10V, I_D = 21A$	$R_{DS(on)}$	--	2.2	3.3	$m\Omega$
	$V_{GS} = 10V, I_D = 21A,$ $T_J = 125^\circ C$		--	3.8	5.7	
	$V_{GS} = 10V, I_D = 21A,$ $T_J = 175^\circ C$		--	4.8	7.3	
	$V_{GS} = 7V, I_D = 17A$		--	2.5	5.1	
Forward Transconductance <small>(Note 3)</small>	$V_{DS} = 10V, I_D = 21A$	g_{fs}	--	68	--	S
Dynamic <small>(Note 4)</small>						
Total Gate Charge	$V_{GS} = 10V, V_{DS} = 20V,$ $I_D = 21A$	Q_g	--	87	--	nC
Total Gate Charge	$V_{GS} = 7V, V_{DS} = 20V,$ $I_D = 17A$	Q_g	--	64	--	
Gate-Source Charge		Q_{gs}	--	20	--	
Gate-Drain Charge		Q_{gd}	--	23	--	
Input Capacitance	$V_{GS} = 0V, V_{DS} = 20V,$ $f = 1.0MHz$	C_{iss}	--	4917	--	pF
Output Capacitance		C_{oss}	--	484	--	
Reverse Transfer Capacitance		C_{rss}	--	276	--	
Gate Resistance	$f = 1.0MHz$	R_g	0.5	1.7	3.4	Ω
Switching <small>(Note 4)</small>						
Turn-On Delay Time	$V_{GS} = 10V, V_{DS} = 20V,$ $I_D = 21A, R_G = 2\Omega$	$t_{d(on)}$	--	10	--	ns
Rise Time		t_r	--	24	--	
Turn-Off Delay Time		$t_{d(off)}$	--	49	--	
Fall Time		t_f	--	23	--	
Source-Drain Diode						
Diode Forward Voltage <small>(Note 3)</small>	$V_{GS} = 0V, I_S = 21A$	V_{SD}	--	--	1	V
Reverse Recovery Time	$I_S = 21A,$ $di/dt = 100A/\mu s$	t_{rr}	--	30	--	ns
Reverse Recovery Charge		Q_{rr}	--	20	--	nC

Notes:

1. Silicon limited current only.
2. $L = 0.3mH, V_{GS} = 10V, V_{DD} = 25V, R_G = 50\Omega, I_{AS} = 36A$, Starting $T_J = 25^\circ C$
3. Pulse test: Pulse Width $\leq 300\mu s$, duty cycle $\leq 2\%$.
4. Switching time is essentially independent of operating temperature.

ORDERING INFORMATION

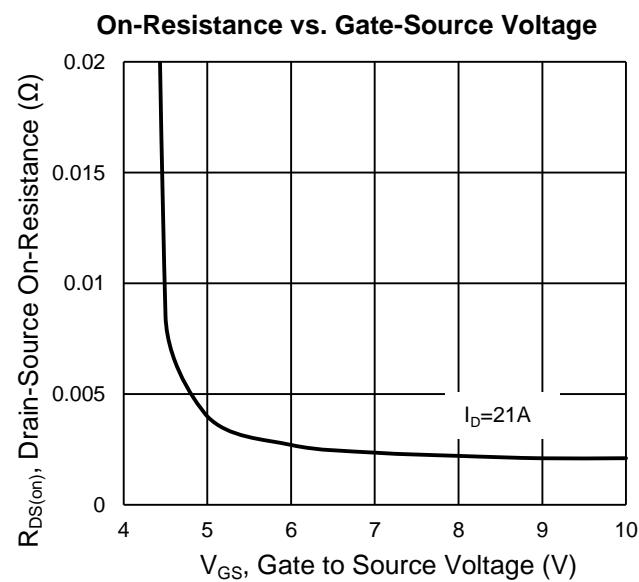
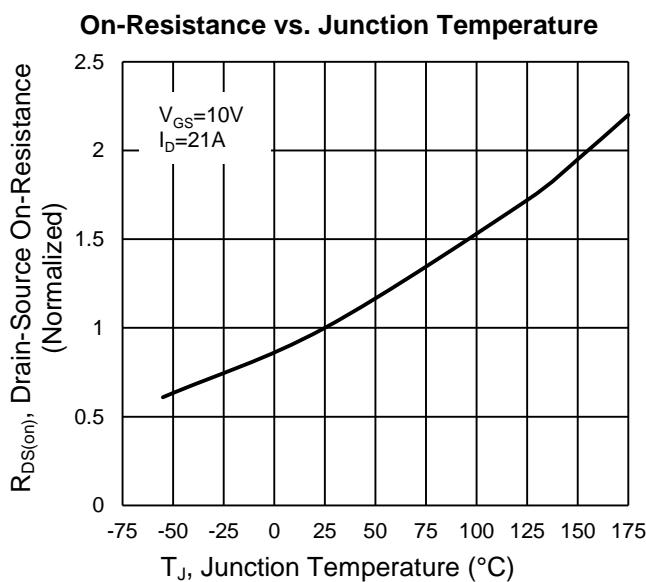
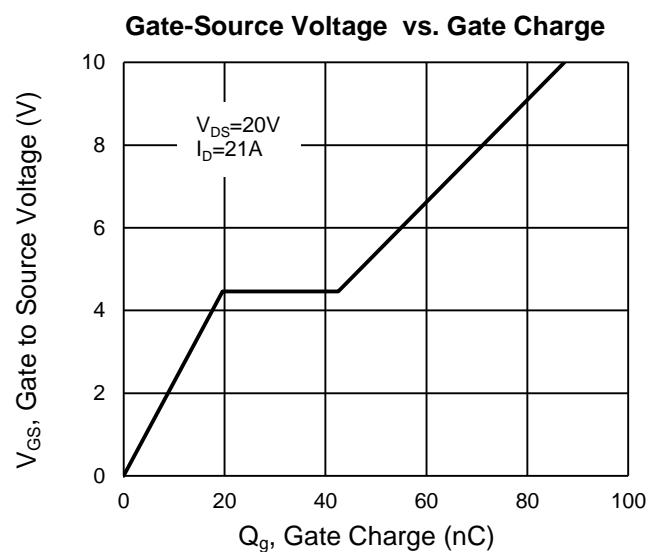
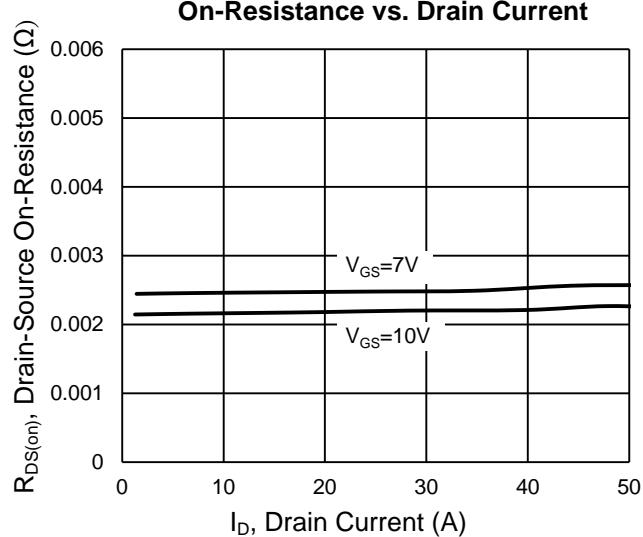
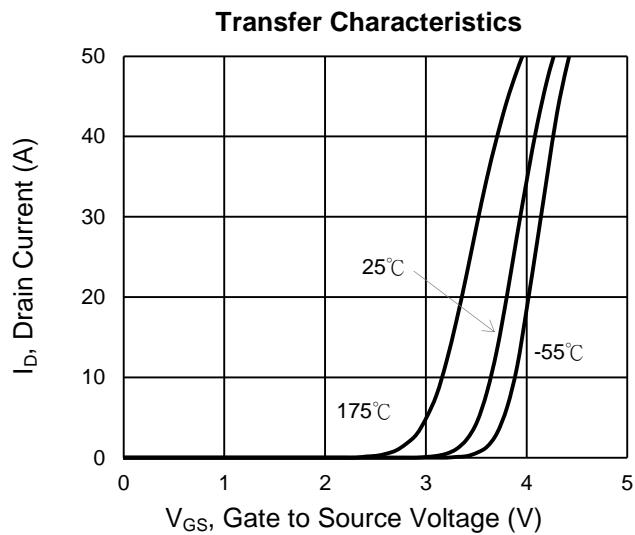
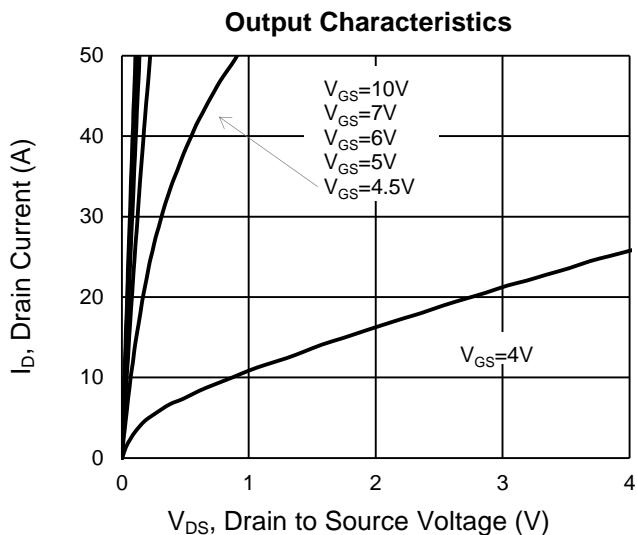
ORDERING CODE	PACKAGE	PACKING
TQM033NB04CR RLG	PDFN56U	2,500pcs / 13" Reel
TQM033NB04CR-V RLG	PDFN56U	2,500pcs / 13" Reel

Notes:

V : HOT test

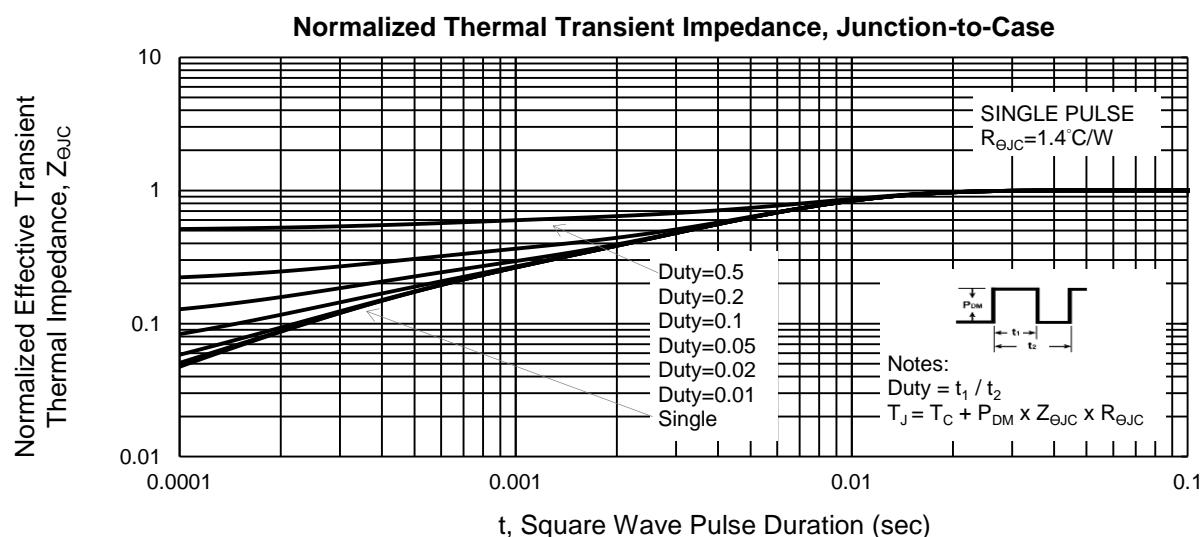
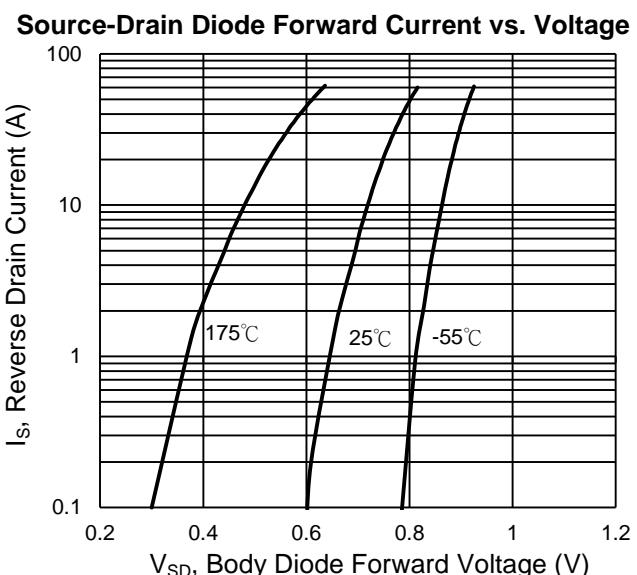
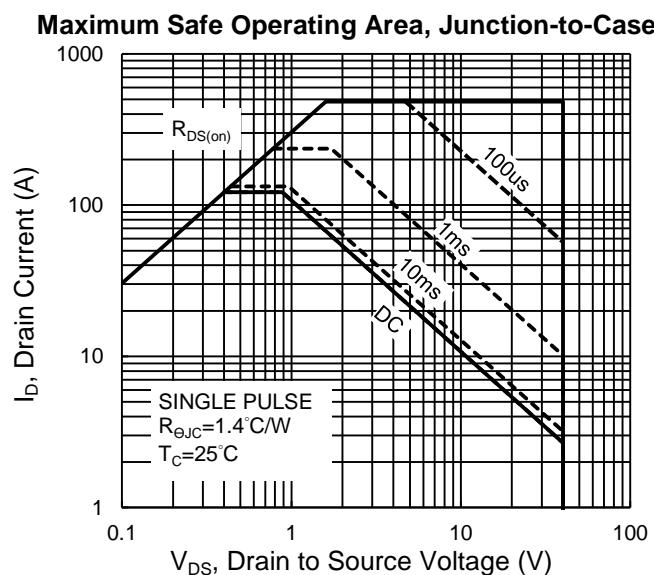
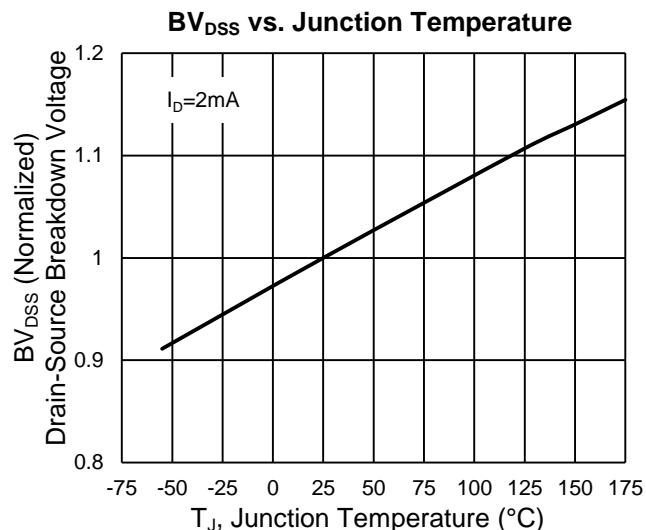
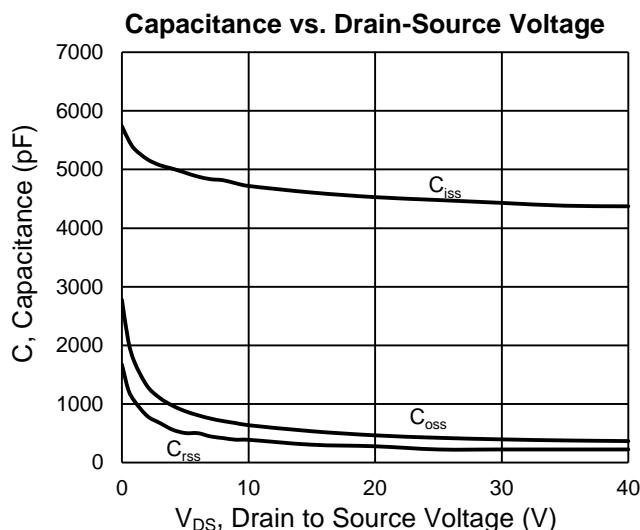
CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

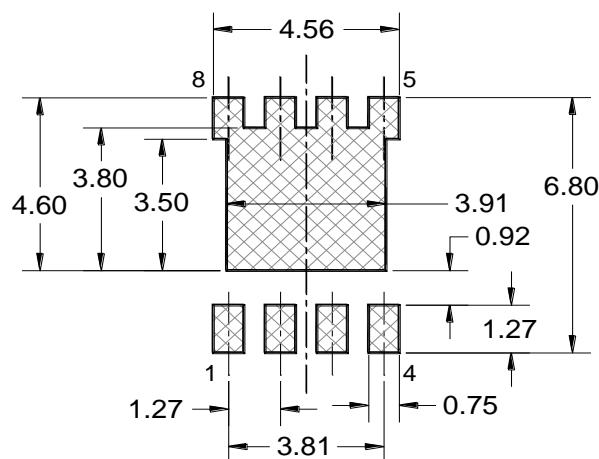
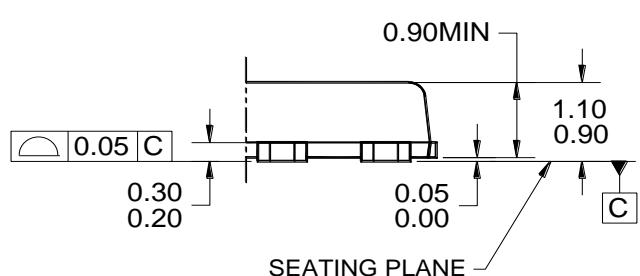
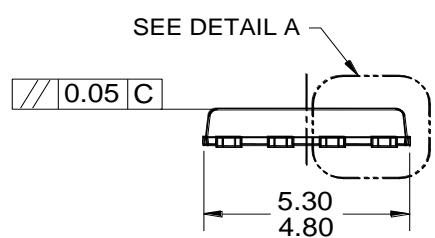
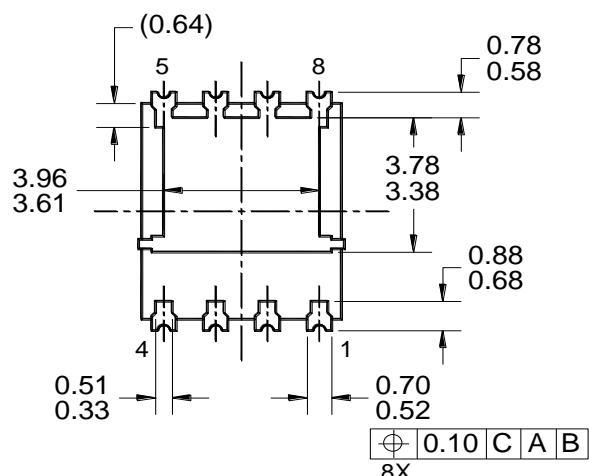
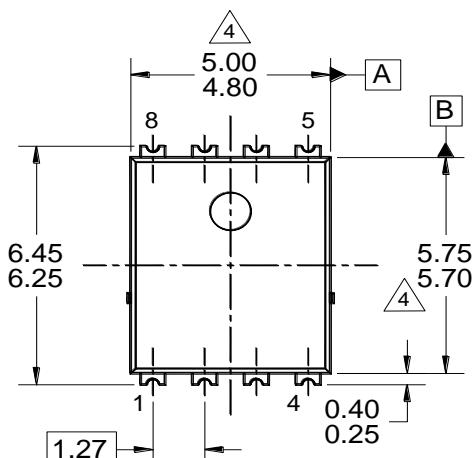
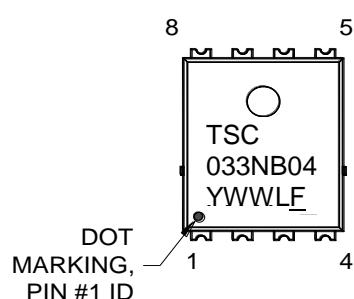


CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)



PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

PDFN56U

SUGGESTED PAD LAYOUT

MARKING DIAGRAM

- NOTES: UNLESS OTHERWISE SPECIFIED
1. ALL DIMENSIONS ARE IN MILLIMETERS.
 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
 3. PACKAGE OUTLINE REFERENCE:
JEITA ED-7500B, EIAJ SC-111BB.
 4. MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
 5. DWG NO. REF: HQ2SD07-PDFN56U-023 REV A.

P/N	= MARKING CODE
Y	= YEAR CODE
WW	= WEEK CODE (01~52)
L	= LOT CODE (1~9, A~Z)
F	= FACTORY CODE
-	= AEC-Q101 QUALIFIED

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